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TYPE 2N2356

I. General Description

The General Electric 2N2356 is a 5 terminal device containing two silicon NPN transistors and is intended for chopper applications in the inverted connection.

II. Case Dimensions

See attached Figure 1.

III. Absolute Maximum Ratings (25°C)

A. Maximum Temperatures

1. Storage	T _{STG}	-65 to 300°C
2. Operating Junction	T _J	-65 to 200°C
3. Lead Temperature (Soldering no time limit)		300°C

B. Maximum Power Dissipation (Both sides or one side only)

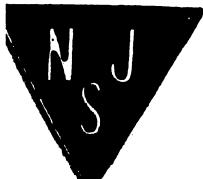
1. Total (Free Air at 25°C)	P _T	0.6 Watts
2. Free Air Derating Factor		3.43 mW/°C
3. Total (Case Temperature at 25°C)	P _T	2.0 Watts
4. Total (Case Temperature at 100°C)	P _T	1.14 Watts
5. Junction to Case Derating Factor		11.4 mW/°C

C. Voltages

1. Collector to Base Voltage	V _{CBO}	25 Volts
2. Emitter to Collector Voltage	V _{ECO}	20 Volts
3. Emitter to Base Voltage	V _{EBO}	7 Volts

D. Current

1. Collector Current	I _C	500 ma
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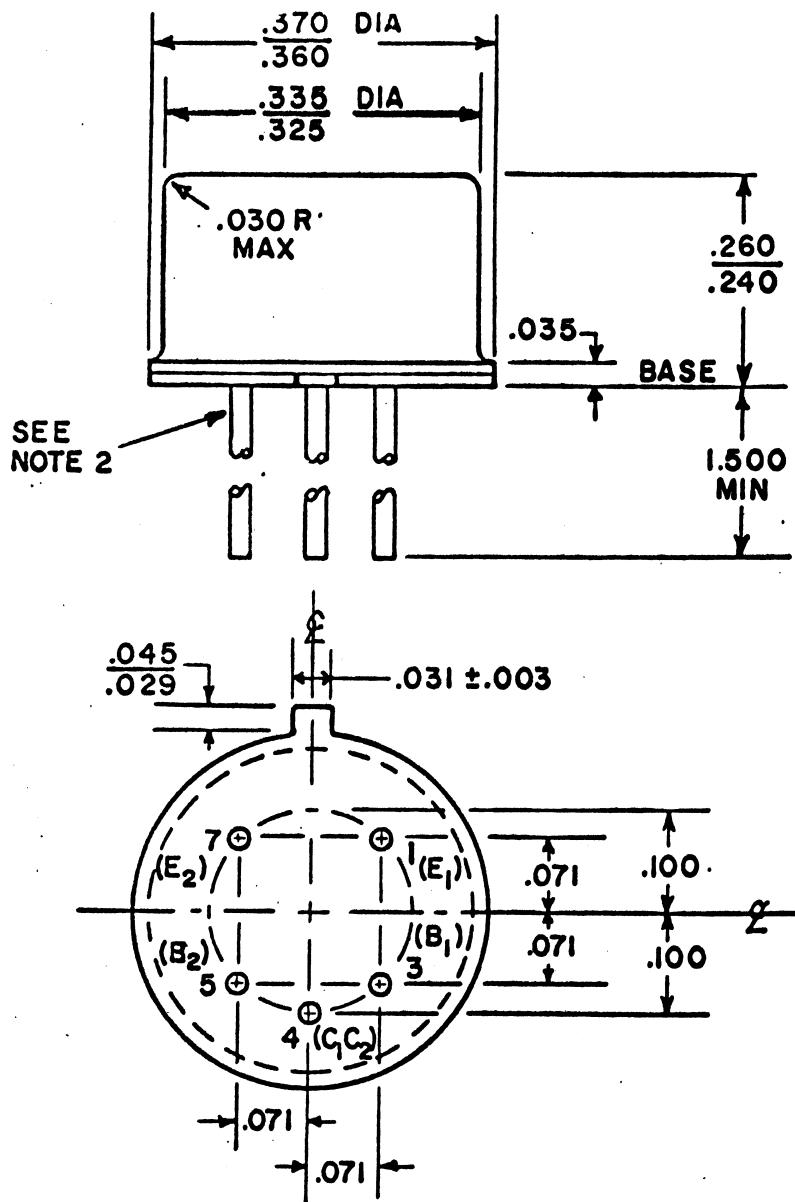
IV. Electrical Characteristics (25°C unless otherwise specified)

A. DC Characteristics	Symbol	Min.	Max.	Units
1. Offset Voltage (Figure 2) ($I_{B1}=I_{B2}=1\text{ma}$, $I_{E1}=I_{E2}=0$)	V_o		50	μvolts
2. Offset Voltage (Figure 2) ($I_{B1}=I_{B2}=1\text{ma}$, $I_{E1}=I_{E2}=0$, $T_A=-55 \text{ to } 25^\circ\text{C}$)	ΔV_o		100	μvolts
3. Offset Voltage (Figure 2) ($I_{B1}=I_{B2}=1\text{ma}$, $I_{E1}=I_{E2}=0$, $T_A=25 \text{ to } 125^\circ\text{C}$)	ΔV_o		100	μvolts
4. Collector Leakage Current (V_{CB1} or $V_{CB2} = 25\text{V}$)	I_{CB1} or I_{CB2}		10	na
5. Emitter Leakage Current (V_{EB1} or $V_{EB2} = 5\text{V}$)	I_{EB1} or I_{EB2}		10	na
6. Collector Breakdown Voltage (I_{C1} or $I_{C2} = 100 \mu\text{a}$)	V_{CB1} or V_{CB2}	25		volts
7. Emitter to Emitter Breakdown Voltage ($I_{E1}=I_{E2}=1\text{ma}$, $I_{B1}=I_{B2}=0$) (Figure 3)	V_{EE0}	20		volts
8. Emitter to Emitter Breakdown Voltage ($I_{E1}=I_{E2}=100\text{ua}$, B_1 , B_2 & C common) (Figure 4)	V_{EES}	7		volts
9. Series on Resistance ($I_{B1}=I_{B2}=1\text{ma}$)	r_s		40	ohms
10. Differential Offset Current ($V_{CB1}=V_{CB2}=6\text{V}$)	ΔI_{OFF}		5	na

B. High Frequency Characteristics

1. Current Transfer Ratio ($I_C=50\text{ma}$, $V_{CE}=10\text{V}$, $f=20\text{mc}$)	h_{fe}	2.5
2. Collector Capacitance ($V_{CB}=10\text{V}$, $I_E=0$, $f=1\text{mc}$)	C_{ob}	20 pf
3. Input Capacitance ($V_{BE}=0$, $I_E=0$)	C_{ib}	85 pf

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NOTES:

1. ALL DIMENSIONS ARE REFERENCE UNLESS TOLERANCED.
2. LEADS ARE $.017^{+.002}_{-.001}$ DIAMETER.
3. DIMENSIONS IN INCHES.
4. TAB IS MEASURED FROM MAXIMUM DIA. OF BASE.
5. LEADS HAVING MAXIMUM DIAMETER (.019) MEASURED IN GAGING PLANE $.054^{+.001}_{-.000}$ BELOW THE BASE OF THE DEVICE SHALL BE WITHIN .007 OF THEIR TRUE LOCATIONS RELATIVE TO A MAXIMUM WIDTH TAB.